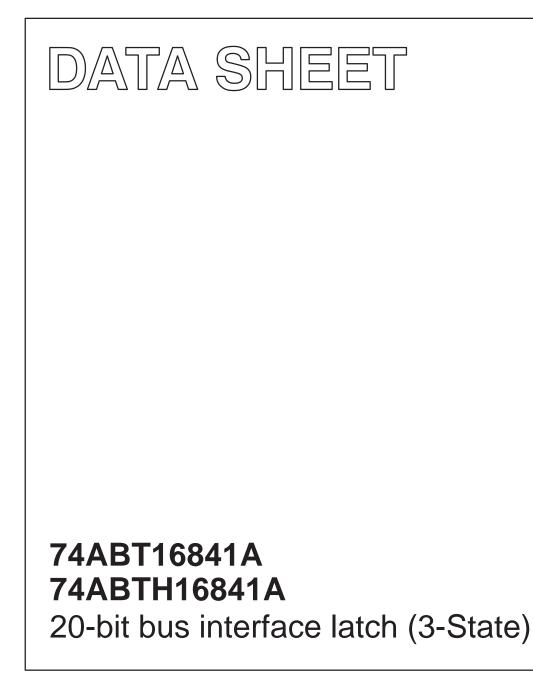
INTEGRATED CIRCUITS



Product specification Supersedes data of 1995 Sep 28 IC23 Data Handbook 1998 Feb 27



Philips Semiconductors

74ABT16841A 74ABTH16841A

FEATURES

- High speed parallel latches
- Live insertion/extraction permitted
- Extra data width for wide address/data paths or buses carrying parity
- Power-up 3-State
- 74ABTH16841A incorporates bus-hold data inputs which eliminate the need for external pull-up resistors to hold unused inputs
- Power-up reset
- Ideal where high speed, light loading, or increased fan-in are required with MOS microprocessors
- Output capability: +64mA/–32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The 74ABT16841A Bus interface latch is designed to provide extra data width for wider data/address paths of buses carrying parity.

The 74ABT16841A consists of two sets of ten D-type latches with 3-State outputs. The flip-flops appear transparent to the data when Latch Enable (nLE) is High. This allows asynchronous operation, as the output transition follows the data in transition. On the nLE High-to-Low transition, the data that meets the setup and hold time is latched.

Data appears on the bus when the Output Enable $(n\overline{OE})$ is Low. When $n\overline{OE}$ is High the output is in the High-impedance state.

Two options are available, 74ABT16841A which does not have the bus-hold feature and 74ABTH16841A which incorporates the bus-hold feature.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nDx to nQx	$C_L = 50 pF; V_{CC} = 5V$	3.1 2.2	ns
C _{IN}	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output capacitance	$V_{O} = 0V \text{ or } V_{CC}; 3\text{-State}$	7	pF
I _{CCZ}		Outputs disabled; $V_{CC} = 5.5V$	500	μA
I _{CCL}	Quiescent supply current	Outputs LOW; $V_{CC} = 5.5V$	10	mA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	–40°C to +85°C	74ABT16841A DL	BT16841A DL	SOT371-1
56-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABT16841A DGG	BT16841A DGG	SOT364-1
56-Pin Plastic SSOP Type III	–40°C to +85°C	74ABTH16841A DL	BH16841A DL	SOT371-1
56-Pin Plastic TSSOP Type II	–40°C to +85°C	74ABTH16841A DGG	BH16841A DGG	SOT364-1

PIN DESCRIPTION

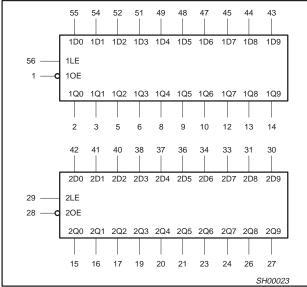
PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 43 42, 41, 40, 38, 37, 36, 34, 33, 31, 30	1D0 – 1D9 2D0 – 2D9	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13, 14 15, 16, 17, 19, 20, 21, 23, 24, 26, 27	1Q0 – 1Q9 2Q0 – 2Q9	Data outputs
1, 28	10E, 20E	Output enable inputs (active-Low)
56, 29	1LE, 2LE	Latch enable inputs (active rising edge)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

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PIN CONFIGURATION

10E [56 1LE
1Q0 [2	55 1D0
1Q1 [3	54 1D1
GND	4	53 GND
1Q2	5	52 1D2
1Q3 [6	51 1D3
V _{CC} [7	50 VCC
1Q4 [8	49 1D4
1Q5 [9	48 1D5
1Q6 [10	47 1D6
GND [11	46 GND
1Q7 [12	45 1D7
1Q8	13	44 1D8
1Q9	14	43 1D9
2Q0 [15	42 2D0
2Q1 [16	41 2D1
2Q2	17	40 2D2
· · · ·	18	39 GND
2Q3 [19	38 2D3
1	20	37 2D4
2Q5 [21	36 2D5
	22	35 VCC
-	23	34 2D6
	24	33 2D7
	25	32 GND
	26	31 2D8
	27	30 2D9
2 0E [28	29 2LE
	L	J
		SA00076

LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)

			-	
1 0E	1	EN2		
1LE	56	C1		
2 0E	28	EN4		
2LE	29	C3		
	55		2	
1D0	54	1D 2 1	3	1Q0
1D1	52	1	1	1Q1
1D2		-	5	1Q2
1D3			6	1Q3
1D4	49	-	8	1Q4
1D5	48	-	9	1Q5
1D6	47	-	10	1Q6
1D7	45	-	12	1Q7
1D8	44	-	13	1Q8
1D9	43	-	14_	1Q9
2D0	42	- 3D 4 V	7 15	2Q0
2D1	41	-	16	2Q1
2D2	40	-	17	2Q2
2D3	38	-	19	2Q3
2D4	37	-	20	2Q4
2D5	36	-	21	2Q5
2D6	34	1	23	2Q6
2D7	33	1	24	2Q7
2D8	31	1	26	2Q8
2D9	30	1	27	2Q9
		L	J SH	100081

FUNCTION TABLE

	INPUTS	6	OUTPUTS	OPERATING MODE
nOE	nLE	nDx	nQ0 – nQ9	OFERATING MODE
L	H H	L H	L H	Transparent
L	$\rightarrow \rightarrow$	l h	L H	Latched
н	Х	Х	Z	High impedance
L	L	Х	NC	Hold

H = High voltage level

High voltage level one set-up time prior to the High-to-Low LE transition h =

= Low voltage level 1

Low voltage level one set-up time prior to the High-to-Low LE 1 = transition

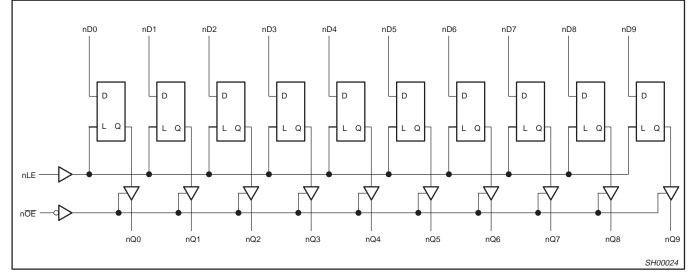
 \downarrow = High-to-Low LE transition

NC= No change

X = Don't care Z = High impedance "off" state

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LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V ₁ < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +5.5	V
		Output in Low state	128	
IOUT	DC output current	Output in High state	-64	- mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STMBOL	PARAMETER	Min	Max	UNIT
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
VIL	Low-level Input voltage		0.8	V
I _{ОН}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
Δt/Δv	Input transition rise or fall rate	0	5	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

						LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS		T _{amb} = +25°C			T _{amb} = -40°C to +85°C		UNIT
				Min	Тур	Max	Min	Max	1
V _{IK}	Input clamp voltage	V _{CC} = 4.5V; I _{IK} = -18mA			-0.9	-1.2		-1.2	V
		V_{CC} = 4.5V; I_{OH} = -3mA; V_I = V_{IL} c	r V _{IH}	2.5	2.9		2.5		V
V _{OH}	High-level output voltage	$V_{CC} = 5.0V; I_{OH} = -3mA; V_I = V_{IL} c$	r V _{IH}	3.0	3.4		3.0		V
		V_{CC} = 4.5V; I_{OH} = -32mA; V_I = V_{IL}	or V _{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	$V_{CC} = 4.5V; I_{OL} = 64mA; V_{I} = V_{IL} c$	or V _{IH}		0.42	0.55		0.55	V
V _{RST}	Power-up output voltage ³	$V_{CC} = 5.5V; I_{O} = 1mA; V_{I} = GND o$	r V _{CC}		0.13	0.55		0.55	V
I	Input leakage current 74ABT16841A	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}$	$V_{CC} = 5.5 V; V_I = V_{CC} \text{ or GND}$		±0.01	±1		±1.0	μA
		$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}$	Control pins		±0.01	±1		±1	μA
I _I	Input leakage current 74ABTH16841A	$V_{CC} = 5.5V; V_{I} = V_{CC}$	Data pins ⁵		0.01	1		1	μA
		$V_{CC} = 5.5V; V_{I} = 0$	Data pins		-2	-3		-5	μΑ
	Due Hald sums at insula6	$V_{CC} = 4.5 V; V_1 = 0.8 V$		35			35		
I _{HOLD}	Bus Hold current inputs ⁶ 74ABTH16841A	$V_{CC} = 4.5 V; V_{I} = 2.0 V$		-75			-75		μA
		$V_{CC} = 5.5V; V_{I} = 0 \text{ to } 5.5V$		±800					
I _{OFF}	Power-off leakage current	V_{CC} = 0.0V; V_O or $V_I \leq 4.5V$			±5.0	±100		±100	μΑ
I _{PU/PD}	Power-up/down 3-State output current ⁴	$V_{CC} = 2.1V$; $V_O = 0.5V$; $V_I = GND$ $V_{OE} = Don't$ care	or V _{CC} ;		±5.0	±50		±50	μA
I _{OZH}	3-State output High current	V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL} or	V _{IH}		5.0	10		10	μΑ
I _{OZL}	3-State output Low current	V_{CC} = 5.5V; V_{O} = 0.5V; V_{I} = V_{IL} or	V _{IH}		-5.0	-10		-10	μΑ
I _{CEX}	Output High leakage current	$V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND$	or V _{CC}		5.0	50		50	μΑ
Ι _Ο	Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$		-50	-70	-180	-50	-180	mA
ICCH		V_{CC} = 5.5V; Outputs High, V_{I} = GN	ID or V _{CC}		0.5	1		1	mA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V_{I} = GN	00		10	19		19	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3-State; V_{I} =	GND or V _{CC}		0.5	1		1	mA
ΔI_{CC}	Additional supply current per input pin ²	V_{CC} = 5.5V; one input at 3.4V, other V_{CC} or GND	er inputs at		0.2	1		1	mA

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
This is the increase in supply current for each input at 3.4V.
For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
This parameter is valid for any V_{CC} between 0V and 2.1V with a transition time of up to 10msec. From V_{CC} = 2.1V to V_{CC} = 5V ± 10% a transition time of up to 100µsec is permitted.
Unused pins at V_{CC} or GND.
This is the hold exceed the second test of the input test the exceed test of the second test.

6. This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS

GND = 0V, $t_R = t_F = 2.5$ ns, $C_L = 50$ pF, $R_L = 500\Omega$

			LIMITS					
SYMBOL	PARAMETER	WAVEFORM	۲	∫ _{amb} = +25° V _{CC} = +5.0\	с /	T _{amb} = -40 V _{CC} = +5	0 to +85°C .0V ±0.5V	UNIT
			MIN	ТҮР	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay nDx to nQx	2	1.1 1.5	3.1 2.2	4.1 3.1	1.1 1.5	4.9 3.6	ns
t _{PLH} t _{PHL}	Propagation delay nLE to nQx	1	1.5 1.0	2.5 2.1	3.3 2.8	1.5 1.0	3.7 3.1	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	4 5	1.2 1.2	2.4 2.2	3.2 2.9	1.2 1.2	4.0 3.6	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	4 5	1.8 1.5	3.0 2.5	4.0 3.2	1.8 1.5	4.9 3.7	ns

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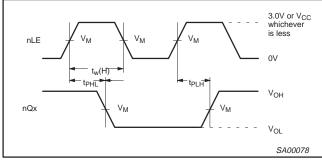
AC SETUP REQUIREMENTS

GND = 0V, $t_R = t_F = 2.5 \text{ns}$, $C_L = 50 \text{pF}$, $R_L = 500 \Omega$

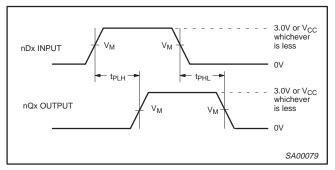
		LIMITS					
SYMBOL	PARAMETER	WAVEFORM	T _{amb} = V _{CC} =	= +25°C = +5.0V	T _{amb} = -40 V _{CC} = +5	0 to +85°C .0V ±0.5V	UNIT
			Min	Тур	Min	Max	
t _s (H) t _s (L)	Setup time, High or Low nDx to nLE	3	2.0 1.0	1.0 0.4	2.0 1.0		ns
t _h (H) t _h (L)	Hold time, High or Low nDx to nLE	3	2.0 2.0	-0.3 -0.7	2.0 2.0		ns
t _w (H)	nLE pulse width High	1	2.9	1.9	2.9		ns

AC WAVEFORMS

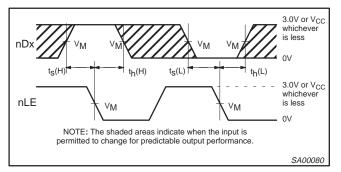
 $V_{M} = 1.5V$, $V_{IN} = GND$ to 3.0V



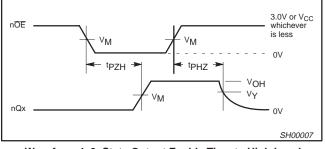
Waveform 1. Propagation Delay, Latch Enable Input to Output, and Enable Pulse Width



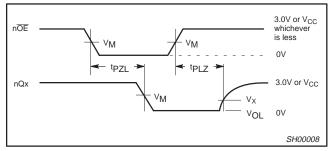
Waveform 2. Propagation Delay for Data to Outputs



Waveform 3. Data Setup and Hold Times



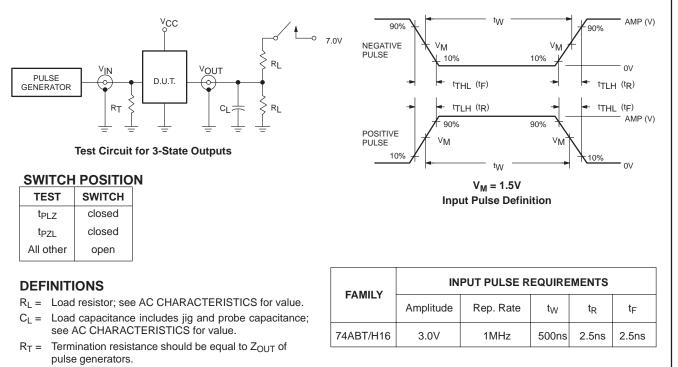
Waveform 4. 3–State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 5. 3–State Output Enable Time to Low Level and Output Disable Time from Low Level

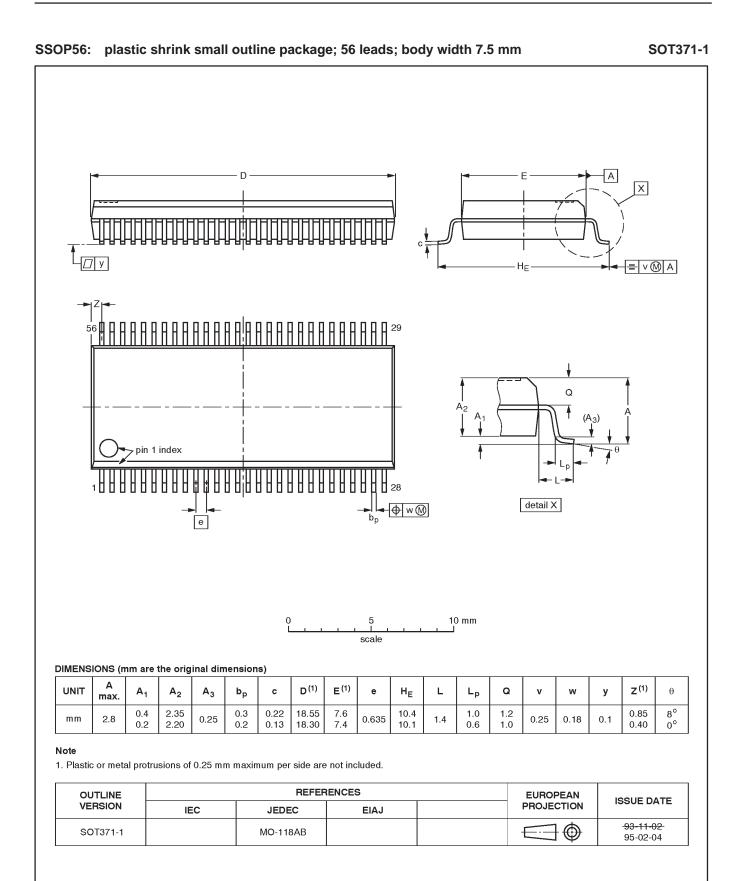
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TEST CIRCUIT AND WAVEFORM

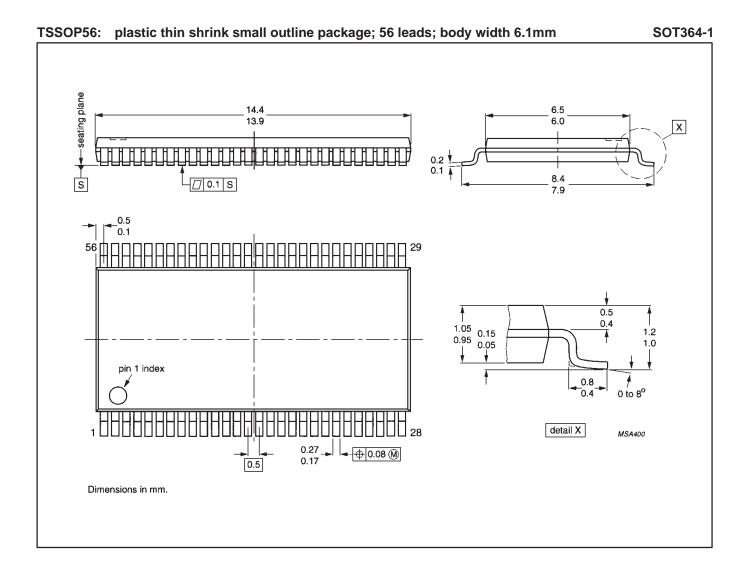


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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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